ICS93V855I

RENESAS

DDR Phase Lock Loop Clock Driver

Recommended Application:

DDR Clock Driver

- Low skew, low jitter PLL clock driver
- External feedback pins for input to output synchronization
- Spread Spectrum tolerant inputs
- With bypass mode mux

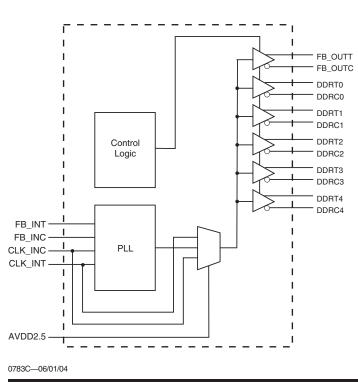
Block Diagram

- Operating frequency 60 to 170 MHz
- Operating Temperature –45°C to +85°C
- CYCLE CYCLE jitter:<75ps
- OUTPUT OUTPUT skew: <60ps
- Output Rise and Fall Time: 650ps 950ps

Pin Configuration

	GND 1 DDRC0 2 DDRT0 3 VDD2.5 4 CLK_INC 6 AVDD2.5 7 AGND 8 GND 8 DDRC1 10 DDRC1 10 DDRT1 11 VDD2.5 12 DDRT2 13 DDRC2 14	2 27 26 25 24 25 24 23 22 23 23 22 20 20 20 19 19 18 20 19 18 20 19 18 20 19 19	DDRC4 DDRT4 VDD2.5 GND FB_OUTC FB_OUTT VDD2.5 FB_INC GND VDD2.5 DDRT3 DDRC3 GND
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28-Pin 4.4mm TSSOP



Functionality

	INPUTS			OUTPUTS			
AVDD	CLK_INT	CLK_INC	DDRT	DDRC	FB_OUTT	FB_OUTC	PLL State
GND	L	Н	L	Н	L	Н	Bypassed/Off
GND	Н	L	Н	L	Н	L	Bypassed/Off
2.5V (nom)	L	Н	L	н	L	Н	On
2.5V (nom)	н	L	Н	L	н	L	On
2.5V (nom)	<20 MHz	<20 MHz	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Off

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Pin Descriptions

PIN #	PIN NAME	PIN TYPE	DESCRIPTION
1	GND	PWR	Ground pin.
2	DDRC0	OUT	"Complimentary" Clock of differential pair output.
3	DDRT0	OUT	"True" Clock of differential pair output.
4	VDD2.5	PWR	Power supply, nominal 2.5V
5	CLK_INT	IN	"True" reference clock input.
6	CLK_INC	IN	"Complimentary" reference clock input.
7	AVDD2.5	PWR	2.5V Analog Power pin for Core PLL
8	AGND	PWR	Analog Ground pin for Core PLL
9	GND	PWR	Ground pin.
10	DDRC1	OUT	"Complimentary" Clock of differential pair output.
11	DDRT1	OUT	"True" Clock of differential pair output.
12	VDD2.5	PWR	Power supply, nominal 2.5V
13	DDRT2	OUT	"True" Clock of differential pair output.
14	DDRC2	OUT	"Complimentary" Clock of differential pair output.
15	GND	PWR	Ground pin.
16	DDRC3	OUT	"Complimentary" Clock of differential pair output.
17	DDRT3	OUT	"True" Clock of differential pair output.
18	VDD2.5	PWR	Power supply, nominal 2.5V
19	GND	PWR	Ground pin.
20	FB_INC	IN	Complement single-ended feedback input, provides feedback signal to internal PLL for synchronization with CLK_INT to eliminate phase error.
21	FB_INT	IN	True single-ended feedback input, provides feedback signal to internal PLL for synchronization with CLK_INT to eliminate phase error.
22	VDD2.5	PWR	Power supply, nominal 2.5V
23	FB_OUTT	OUT	True single-ended feedback output, dedicated external feedback. It switches at the same frequency as other DDR outputs, This output must be connect to FB_INT.
24	FB_OUTC	OUT	Complement single-ended feedback output, dedicated external feedback. It switches at the same frequency as other DDR outputs, This output must be connect to FB_INC.
25	GND	PWR	Ground pin.
26	VDD2.5	PWR	Power supply, nominal 2.5V
27	DDRT4	OUT	"True" Clock of differential pair output.
28	DDRC4	OUT	"Complimentary" Clock of differential pair output.

Absolute Maximum Ratings

Supply Voltage: (VDD & AVDD)
(VDDI)0.5V to 4.6V
Logic Inputs: VI V_{SS} –0.5 V to V_{DD} +0.5 V
Logic Outputs: VO V_{SS} –0.5 V to V_{DD} +0.5 V
Input clamp current: IIK (VI < 0 or VI > VDD) +/- 50mA
Output clamp current: IOK (VO < 0 or VO > VDD) +/- 50mA
Continuous output current: IO (VO = 0 to VDD) +/- 50mA
Storage Temperature

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

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		e AVDD, VDD = 2.5 V +/- 0.2V (,	1
PARAMETER	SYMBOL		MIN	TYP	MAX	UNITS
Input High Current	I _{IH}	$V_{I} = V_{DD}$ or GND	5			μA
Input Low Current	۱ _{IL}	$V_{I} = V_{DD}$ or GND			5	μA
Operating Supply	I _{DD2.5}	$C_L = 0pf, R_L = 120 \text{ ohms}$			250	mA
Current	I _{DDPD}	$C_L = 0pf, R_L = 120 \text{ ohms}$			100	μA
Output High Current	I _{он}	$V_{DD} = 2.3V, V_{OUT} = 1V$	-18			mA
Output Low Current	I _{OL}	$V_{DD} = 2.3V, V_{OUT} = 1.2V$	26			mA
High Impedance Output Current	I _{OZ}	V_{DD} =2.7V, Vout= V_{DD} or GND			±10	μA
Input Clamp Voltage	V _{IK}	lin = -18mA			-1.2	V
High-level output voltage	V _{OH}	$V_{DD} = min to max,$ $I_{OH} = -1 mA$	V _{DD} - 0.1			V
nign-ievel output voltage		V _{DD} = 2.3V, I _{OH} = -12 mA	1.7			V
Low-level output voltage	V _{OL}	V _{DD} = min to max I _{OL} =1 mA			0.1	
		V _{DD} = 2.3V I _{OH} =12 mA			0.6	V
Input Capacitance ¹	C _{IN}	VI = V _{DD} or GND		3		pF
Output Capacitance ¹	C _{OUT}	VI = V _{DD} or GND		3		pF

Electrical Characteristics - Input/Supply/Common Output Parameters

¹Guaranteed by design and characterization, not 100% tested in production.

Renesas ICS93V855I

DC Electrical Characteristics

 $T_A = -45 \,^{\circ}C$ to $+85 \,^{\circ}C$; Supply Voltage AVDD, VDD = 2.5 V +/- 0.2V (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	$V_{\text{DD}\text{Q}},A_{\text{VDD}}$		2.3	2.5	2.7	V
Low level input voltage	V _{IL}	CLK_INT, CLK_INC, FB_INC, FB_INT		0.4	V _{DD} /2 - 0.18	V
High level input voltage	V _{IH}	CLK_INT, CLK_INC, FB_INC, FB_INT	V _{DD} /2 + 0.18	2.1		V
DC input signal voltage (note 2)	V _{IN}		-0.3		V _{DD} + 0.3	V
Differential input signal	V _{ID}	DC - CLK_INT, CLK_INC, FB_INC, FB_INT	0.36		V _{DD} + 0.6	V
voltage (note 3)	VID	AC - CLK_INT, CLK_INC, FB_INC, FB_INT	0.7		V _{DD} + 0.6	V
Output differential cross- voltage (note 4)	V _{ox}		V _{DD} /2 - 0.15		$V_{DD}/2 + 0.15$	V
Input differential cross- voltage (note 4)	V _{IX}		V _{DD} /2 - 0.2	$V_{DD}/2$	$V_{DD}/2 + 0.2$	V
Operating free-air temperature	T _A		-45		85	°C

Notes:

1 Unused inputs must be held high or low to prevent them from floating.

2 DC input signal voltage specifies the allowable DC excursion of differential input.

3 Differential inputs signal voltages specifies the differential voltage [VT-VCP] required for switching, where VTR is the true input level and VCP is the complementary input level.

4 Differential cross-point voltage is expected to track variations of VDD and is the voltage at which the differential signal must be crossing.



Switching Characteristics

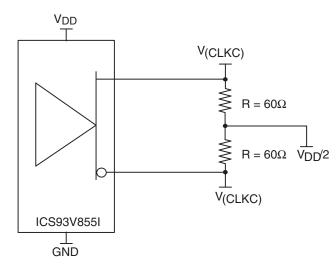
 $T_A = -45$ °C to +85 °C; Supply Voltage AVDD, VDD = 2.5 V +/- 0.2V (unless otherwise stated)

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNITS
Max clock frequency ³	freq _{op}		33		233	MHz
Application Frequency Range ³	$freq_{App}$		60		170	MHz
Input clock duty cycle	d _{tin}		40		60	%
Output clock slew rate	t _{sl(o)}		1		2	v/ns
CLK stabilization	T _{STAB}				100	μs
Low-to high level propagation delay time	t _{PLH} ¹	CLK_IN to any output		5.5		ns
High-to low level propagation delay time	t _{PHL} 1	CLK_IN to any output		5.5		ns
Output enable time	t _{en}	PD# to any output		5		ns
Output disable time	t _{dis}	PD# to any output		5		ns
Period jitter	t _{jit (per)}		-75		75	ps
Half-period jitter	t _{jit(hper)}]	-100		100	ps
Input clock slew rate	t _{sl(I)}	Over the application	1		2	v/ns
Cycle to Cycle Jitter	t _{cyc} -t _{cyc}	frequency range	-75		75	ps
Phase error ⁴	t _(phase error)]	-50		50	ps
Output to Output Skew	t _{skew}]		40	60	ps
Rise Time, Fall Time	t _r , t _f	Load = 1200 /16pF	650	800	950	ps

Notes:

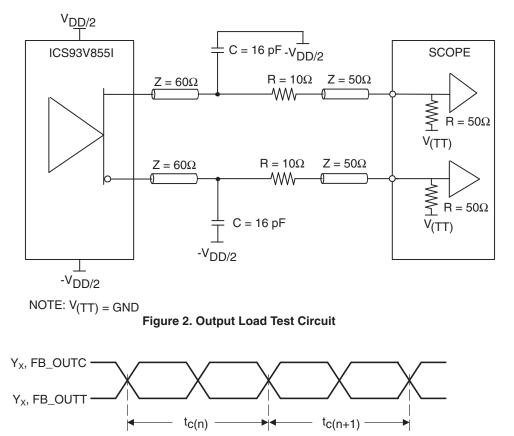
- 1. Refers to transition on noninverting output in PLL bypass mode.
- 2. While the pulse skew is almost constant over frequency, the duty cycle error increases at higher frequencies. This is due to the formula: duty cycle=twH/tc, were the cycle (tc) decreases as the frequency goes up.
- 3. Switching characteristics are guaranteed for application frequency range. The PLL Locks over the Max Clock Frequency range, but the device doe not necessarily meet other timing parameters.
- 4. Does not include jitter.

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Parameter Measurement Information

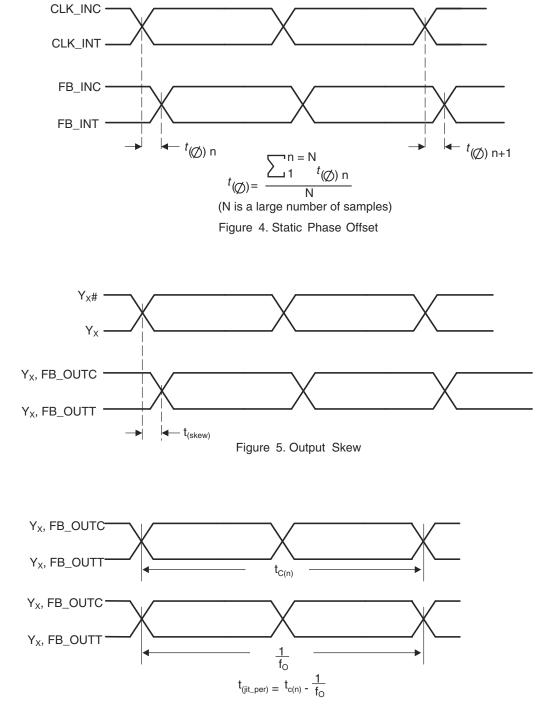




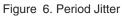
 $t_{jit(cc)} = t_{c(n)} \pm t_{c(n+1)}$

Figure 3. Cycle-to-Cycle Jitter

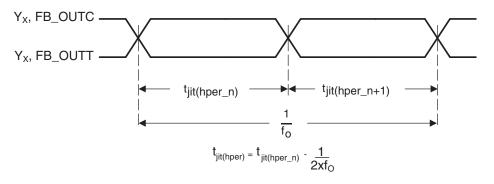




Parameter Measurement Information







Parameter Measurement Information

Figure 7. Half-Period Jitter

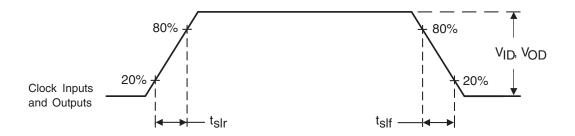
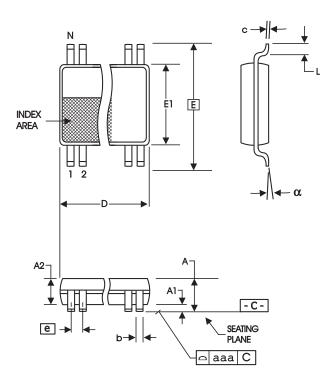


Figure 8. Input and Output Slew Rates



	In Milli	meters	In Inches		
SYMBOL	COMMON D	IMENSIONS	COMMON DIMENSIONS		
	MIN	MAX	MIN	MAX	
А		1.20		.047	
A1	0.05	0.15	.002	.006	
A2	0.80	1.05	.032	.041	
b	0.19	0.30	.007	.012	
С	0.09	0.20	.0035	.008	
D	SEE VAF	RIATIONS	SEE VARIATIONS		
E	6.40 E	BASIC	0.252 BASIC		
E1	4.30	4.50	.169	.177	
е	0.65 E	BASIC	0.0256 BASIC		
L	0.45	0.75	.018	.030	
N	SEE VAF	RIATIONS	SEE VAF	RIATIONS	
а	0°	8°	0°	8°	
aaa		0.10		.004	

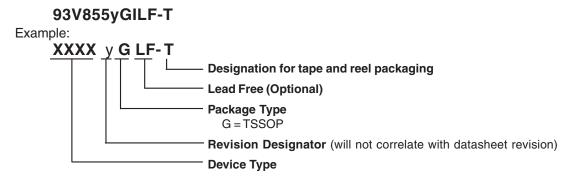
VARIATIONS

N	Dr	nm.	D (inch)			
IN	MIN	MAX	MIN	MAX		
28	9.60	9.80	.378	.386		
Potoronoo Doo , JEDEC Dublication OF MO 152						

Reference Doc.: JEDEC Publication 95, MO-153 10-0035

4.40 mm. Body, 0.65 mm. pitch TSSOP (173 mil) (0.0256 lnch)

Ordering Information



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